

650V 40A Trench and Field Stop IGBT

JJT40N65UK

Key Features:

- $V_{CE} = 650V$
- $I_C = 40A @ V_{CE} = 100$
- $V_{CE(sat)} = 1.9V$

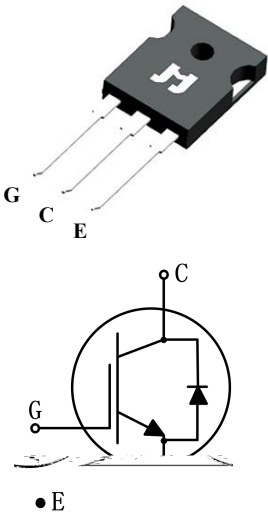
TO-247i

Features:

- Trench and field-stop technology.
- Easy parallel switching capability.

Benefits:

- High efficiency for inverters.
- High ruggedness performance.
- RoHS compliant.



Applications:

- PFC applications
- Welding machines

Package

Type	Marking	Package	Packaging Method
JJT40N65UK	T4065UK	TO-247i	Tube

M

	P		
CES	Collector-emitter voltage	650	V
GES	Gate-emitter voltage	±20	V
C	Continuous collector current ($T_C=25^\circ\text{C}$)	80	A
	Continuous collector current ($T_C=100^\circ\text{C}$)	40	A
CM	Pulsed collector current, I_P limited by t_{vjmax}	160	A
F	Diode continuous forward current ($T_C=100^\circ\text{C}$)	40	A
FM	Diode maximum current, I_P limited by t_{vjmax}	160	A
P_{tot}	Power dissipation ($T_C=25^\circ\text{C}$)	174	W
	Power dissipation ($T_C=100^\circ\text{C}$)	87	W
T_{vj}	Operating junction temperature range	-40 to +175	
T_{stg}	Storage temperature range	-55 to +150	

	P			
		θ_{JA}	θ_{JC}	
θ_{JC}	Thermal resistance, junction to case for IGBT	-	0.86	K/ W
θ_{JC}	Thermal resistance, junction to case for Diode	-	1.4	K/ W
θ_{JA}	Thermal resistance, junction to ambient	-	40	K/ W

**E IGB** ($v_j=25$ unless otherwise specified)

Static characteristics

	P					
			M .	.	M .	
C_{ES}	Collector-emitter breakdown voltage	$V_{GE}=0V, I_C=250\mu A$	650	-	-	V
C_{ES}	Collector-emitter leakage current	$V_{CE}=650V, V_{GE}=0V$	-	-	50	μA
G_{ES}	Gate leakage current, forward	$V_{GE}=20V, V_{CE}=0V$	-	-	100	nA
	Gate leakage current, reverse	$V_{GE}=-20V, V_{CE}=0V$	-	-	-100	nA
$V_{GE(th)}$	Gate-emitter threshold voltage	$V_{GE}=V_{CE}, I_C=1mA$	4.0	5.0	6.0	V
$V_{CE(sat)}$	Collector-emitter saturation voltage	$V_{GE}=15V, I_C=40A$	-	1.9	-	V
		$V_{GE}=15V, I_C=40A, v_j=175$	-	2.6	-	V

Dynamic characteristics

	P					
			M .	.	M .	
C_{ies}	Input capacitance	$V_{CE}=30V$ $V_{GE}=0V$ $f=1MHz$	-	2480	-	pF
C_{oes}	Output capacitance		-	95	-	pF
C_{res}	Reverse transfer capacitance		-	21	-	pF
Q_g	Total gate charge	$V_{CC}=520V$ $V_{GE}=15V$ $I_C=40A$	-	78	-	nC

Switching characteristics

	P					
			M .	. M .	M .	
d(on)	Turn-on delay time	$V_{CC}=400V$ $V_{GE}=0/15V$ $I_C=40A$ $R_G=10\Omega$ Inductive load	-	32	-	ns
r	Rise time		-	55	-	ns
d(off)	Turn-off delay time		-	106	-	ns
f	Fall time		-	51	-	ns
on	Turn-on energy		-	0.9	-	mJ
off	Turn-off energy		-	0.5	-	mJ
ts	Total switching energy		-	1.4	-	mJ
d(on)	Turn-on delay time	$V_{CC}=400V$ $V_{GE}=0/15V$ $I_C=40A$ $R_G=10\Omega$ Inductive load $v_{vj}=175$	-	28	-	ns
r	Rise time		-	52	-	ns
d(off)	Turn-off delay time		-	128	-	ns
f	Fall time		-	75	-	ns
on	Turn-on energy		-	1.4	-	mJ
off	Turn-off energy		-	0.7	-	mJ
ts	Total switching energy		-	2.1	-	mJ



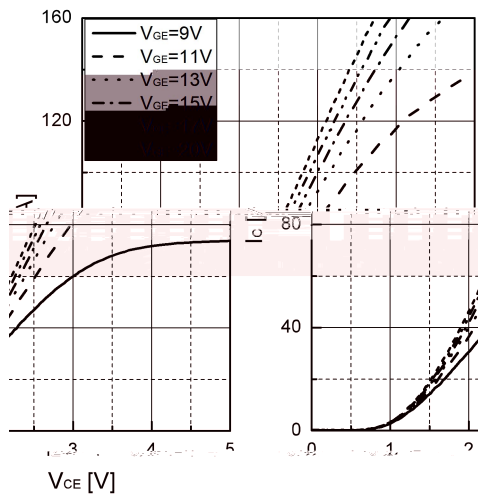


Fig 1. Typical output characteristic ($v_j=25$)

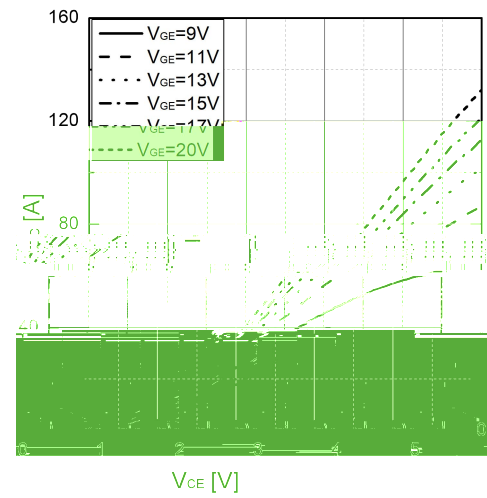


Fig 2. Typical output characteristic ($v_j=175$)

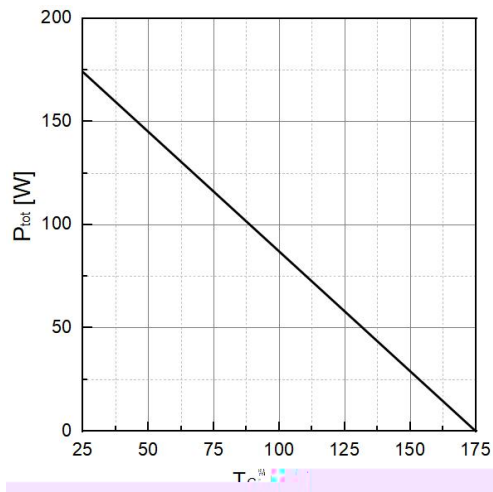


Fig 3. Power dissipation as a function of

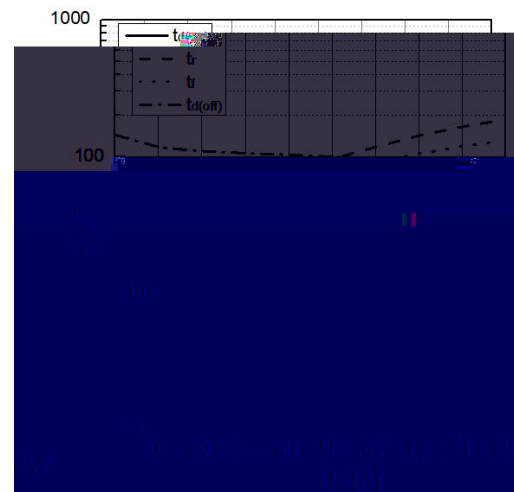


Fig 4. Typical switching time as a function of C

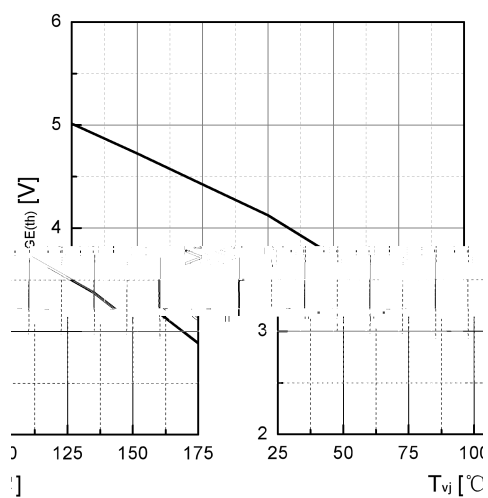


Fig 5. Typical $V_{GE(th)}$ as a function of v_j

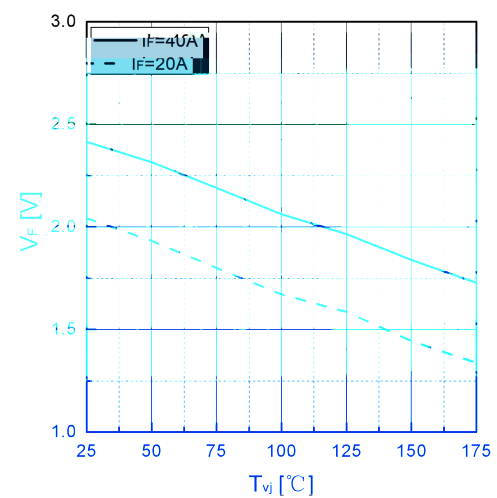


Fig 6. Typical V_F as a function of v_j

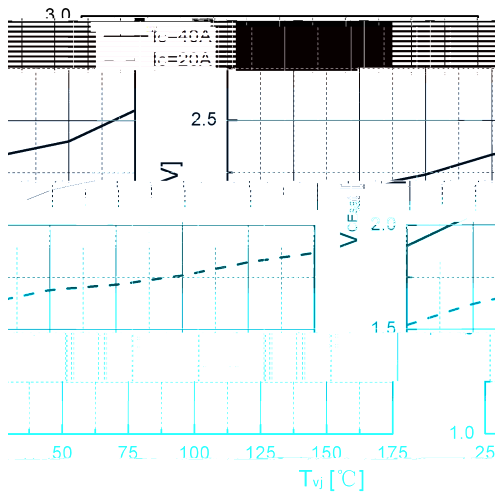


Fig 7. Typical $C_{E_{sat}}$ as a function of T_{vj}

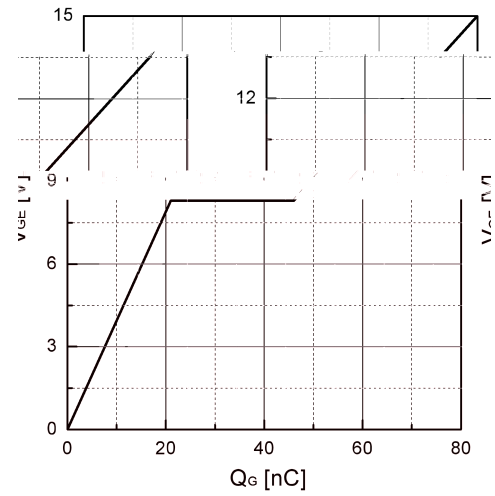


Fig 8. Typical Gate charge

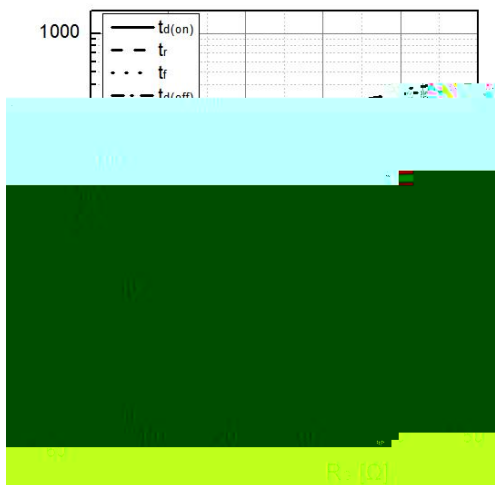


Fig 9. Typical switching times as a function of I_c

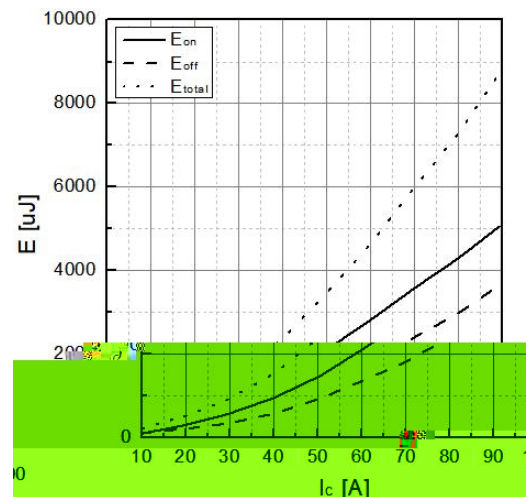


Fig 10. Typical switching energy losses as a function of I_c

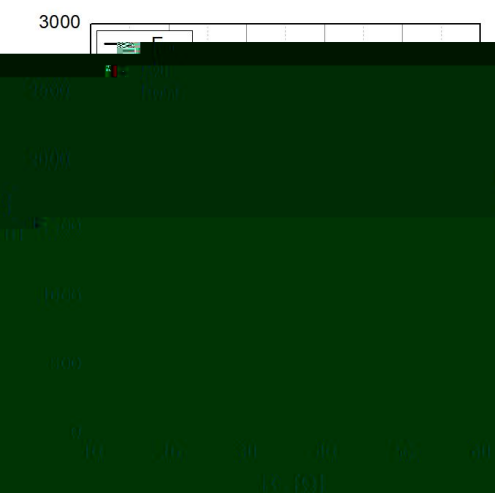


Fig 11. Typical switching energy losses as a function of T_{vj}

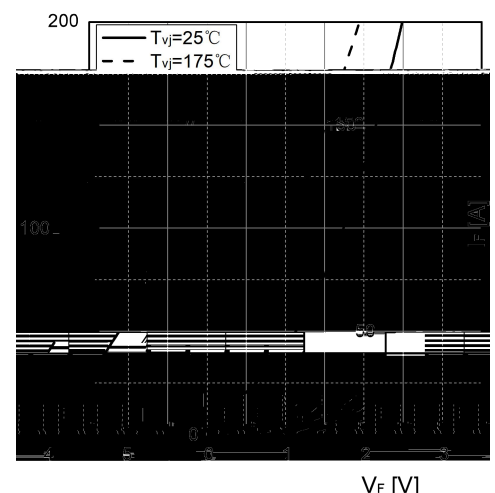


Fig 12. Typical V_F as a function of I_F

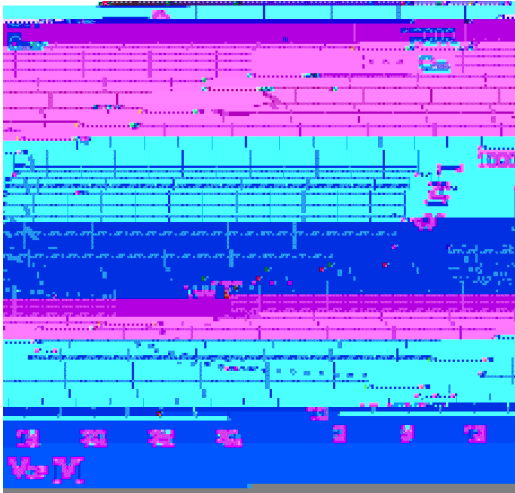


Fig 13. Typical capacitance as a function of V_{CE}
($f=1\text{MHz}$, $V_{GE}=0\text{V}$)

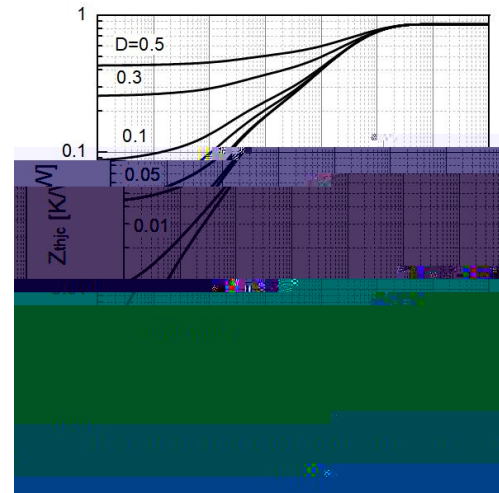
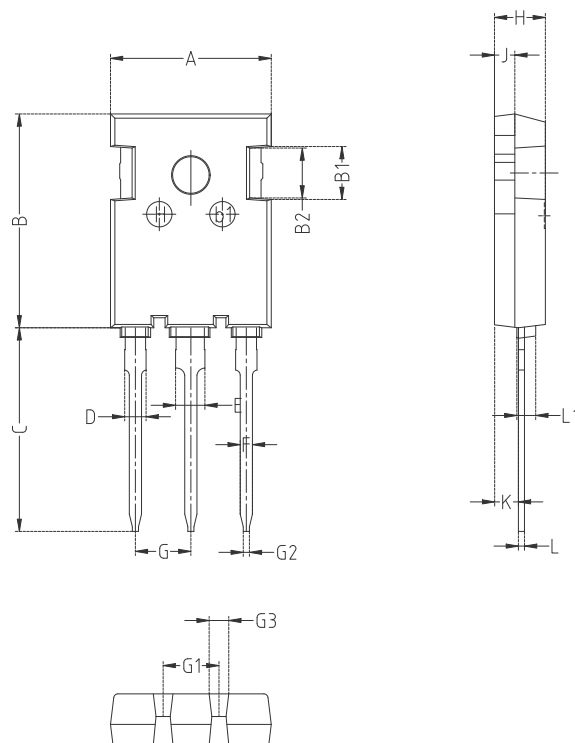


Fig 14. Transient thermal impedance of IGBT

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TO-247i



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	15.95	16.00	16.05	0.627	0.629	0.631
B	21.85	21.90	21.92	0.860	0.862	0.864
B1	5.15	5.20	5.25	0.202	0.204	0.206
B2	4.32	4.37	4.42	0.170	0.172	0.174
C	19.01	19.11	19.21	0.748	0.752	0.756
D	2.07	2.10	2.13	0.081	0.082	0.083
E	3.07	3.10	3.13	0.120	0.122	0.123
F	1.15	1.20	1.25	0.045	0.047	0.049
G	5.45REF			0.214REF		
G1	5.85	5.90	5.95	0.230	0.232	0.234
G2	-	0.60	-	-	0.023	-
G3	1.76	1.81	1.86	0.069	0.071	0.073
H	4.95	5.00	5.05	0.194	0.196	0.198
J	1.44	1.49	1.54	0.056	0.058	0.060
K	2.30	2.35	2.40	0.090	0.092	0.094
L	0.59	0.60	0.61	0.023	0.023	0.024
L1	1.85	1.90	1.95	0.072	0.074	0.076



Date	Revision	Changes
2026-06-01	Rev 1.0	Release of the datasheet

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